

32K-Word By 8 Bit

CS18LV02565

Revision History

<u>Rev. No.</u> 2.0 History Initial issue with new naming rule Issue Date Dec.29,2004 **Remark**





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CS18LV02565

■ GENERAL DESCRIPTION

The CS18LV02565 is a high performance, high speed and super low power CMOS Static Random Access Memory organized as 32,768 words by 8bits and operates for a single 4.5 to 5.5V supply voltage. Advanced CMOS technology and circuit techniques provide both high speed, super low power features and maximum access time of 55/70ns in 5.0V operation. Easy memory expansion is provided by an active LOW chip enable (/CE) and active LOW output enable (/OE).

The CS18LV02565 has an automatic power down feature, reducing the power consumption significantly when chip is deselected. The CS18LV02565 is available in JEDEC standard 28-pin TSOP I (8x13.4 mm), SOP (330 mil) and PDIP (600 mil) packages.

■ FEATURES

- ➢ Wide operation voltage : 4.5 ∼ 5.5V
- Ultra low power consumption : 2mA@1MHz (Max.), Vcc=5.0V.

1.0 uA (Typ.) CMOS standby current 70ns.

- High speed access time : 55/70ns.
- Automatic power down when chip is deselected.
- > Three state outputs and TTL compatible.
- Data retention supply voltage as low as 1.5V.
- > Easy expansion with /CE and /OE options.

PRODUCT FAMILY

Product Family	Operating Temp.	Vcc Range	Speed (ns)	Standby Current(Typ.) I _{CCSB1}	Package Type
					28 SOP
	0~70°C		55/70	1.0 uA	28 TSOP I
	0~70 C		55/70	(Vcc = 5.0V)	28 PDIP
CS18LV02565		4.5~5.5V			Dice
C316EV02505		4.5~5.5V			28 SOP
	-40~85°C		55/70	1.5 uA	28 TSOP I 28 PDIP Dice 28 SOP 28 TSOP I 28 PDIP
	-40~85 C		55/70	(Vcc= 5.0V)	28 PDIP
					Dice

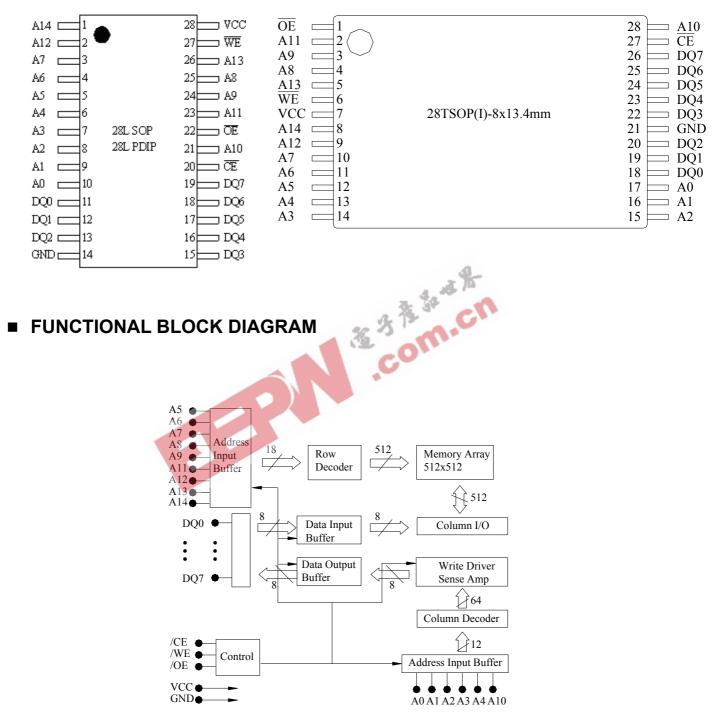
Rev. 2.0



32K-Word By 8 Bit

CS18LV02565

■ PIN CONFIGURATIONS



Rev. 2.0



32K-Word By 8 Bit

CS18LV02565

■ PIN DESCRIPTIONS

Name	Туре	Function
A0 – A14	Input	Address inputs for selecting one of the 32,768 x 8 bit words in the RAM
		/CE is active LOW. Chip enable must be active when data read from or write
/CE	Input	to the device. If chip enable is not active, the device is deselected and in a
/0L	mput	standby power mode. The DQ pins will be in high impedance state when the
		device is deselected.
		The Write enable input is active LOW. It controls read and write operations.
/WE	Input	With the chip selected, when /WE is HIGH and /OE is LOW, output data will
/**∟	mput	be present on the DQ pins, when /WE is LOW, the data present on the DQ
		pins will be written into the selected memory location.
		The output enable input is active LOW. If the output enable is active while the
/OE	Input	chip is selected and the write enable is inactive, data will be present on the
/OE	mput	DQ pins and they will be enabled. The DQ pins will be in the high impedance
		state when /OE is inactive.
DQ0~DQ7	I/O	These 8 bi-directional ports are used to read data from or write data into the
ושט~טשט	1/0	RAM.
Vcc	Power	Power Supply
Gnd	Power	Ground

■ TRUTH TABLE

Mode	/CE	/WE	/OE	DQ0~7	Vcc Current
Standby	Н	Х	Х	High Z	I _{CCSB} , I _{CCSB1}
Output Disabled	L	Н	Н	High Z	I _{CC}
Read	L	Н	L	D _{OUT}	I _{CC}
Write	L	L	Х	D _{IN}	I _{CC}



32K-Word By 8 Bit

CS18LV02565

■ ABSOLUTE MAXIMUM RATINGS⁽¹⁾

Symbol	Parameter	Rating	Unit
V _{TERM}	Terminal Voltage with Respect to GND	-0.5 to Vcc+0.5	V
T _{BIAS}	Temperature Under Bias	-40 to +125	°C
Т _{sтg}	Storage Temperature	-60 to +150	°C
Ρ _τ	Power Dissipation	1.0	W
Ι _{ουτ}	DC Output Current	20	mA

1. Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

OPERATING RANGE

	- 44	A PE
OPERATING RAN	GE	cn
Range	Ambient Temperature	Vcc
Commercial	0~70°C	4.5~5.5V
Industrial	-40~85°C	4.5~5.5V



Symbol	Parameter Conduction		MAX.	Unit
C _{IN}	Input Capacitance	VIN=0V	6	pF
C _{DQ}	Input/Output Capacitance	VI/O=0V	8	pF

1. This parameter is guaranteed, and not 100% tested.



32K-Word By 8 Bit

CS18LV02565

DC E	DC ELECTRICAL CHARACTERISTICS (TA = 0° ~70°C, Vcc = 5.0V)						
Name	Parameter	Test Condition	MIN	TYP ⁽¹⁾	MAX	Unit	
V _{IL}	Guaranteed Input Low Voltage ⁽²⁾	Vcc=5.0V	-0.5		1.5	v	
V _{IH}	Guaranteed Input High Voltage ⁽²⁾	Vcc=5.0V	2.5		Vcc+0.2	v	
IIL	Input Leakage Current	V_{CC} =MAX, V_{IN} =0 to V_{CC}	-1		1	uA	
I _{OL}	Output Leakage Current	V _{CC} =MAX, /CE=V _{IN} , or /OE=V _{IN} , V _{IO} =0V to V _{CC}	-1		1	uA	
V _{OL}	Output Low Voltage	V _{CC} =MAX, I _{OL} = 1mA			0.4	v	
V _{OH}	Output High Voltage	V _{CC} =MIN, I _{OH} = -1mA	2.2			v	
I _{CC}	Operating Power Supply Current	/CE=V _{IL} , I _{DQ} =0mA, F=F _{MAX} =1/ t _{RC}	- 10-5	St.	20	mA	
I _{CCSB}	TTL Standby Supply	/CE=V _{IH} , I _{DQ} =0mA,	12	C	1	mA	
I _{CCSB1}	CMOS Standby Current	/CE \ge V _{cc} -0.2V, V _{IN} \ge V _{cc} -0.2V or V _{IN} \le 0.2V,	on	1.0	4	uA	

1. Typical characteristics are at TA = 25° C.

2. These are absolute values with respect to device ground and all overshoots due to system or tester notice are included.

DATA RETENTION CHARACTERISTICS ($TA = 0^{\circ} \sim 70^{\circ}C$, Vcc = 5.0V)

Name	Parameter	Test Condition	MIN	TYP ⁽¹⁾	MAX	Unit
V _{DR}	V _{CC} for Data Retention	/CE \geq V _{CC} -0.2V, V _{IN} \geq	1.5			V
V DR		V_{CC} -0.2V or $V_{IN} \leq 0.2V$	1.0			v
	Data Retention Current	/CE \geq V _{CC} -0.2V, V _{IN} \geq		0.5	3	uA
ICCDR		$V_{CC}\text{-}0.2V$ or $V_{IN}{\leq}0.2V$		0.5	5	uA
т	Chip Deselect to Data	Refer to	0			20
T _{CDR}	Retention Time	Retention Waveform	0			ns
t _R	Operation Recovery Time		t _{RC} (2)			ns

1. TA = 25[°]C.

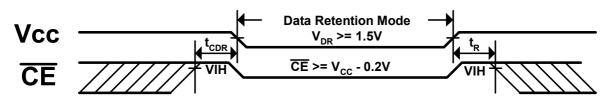
2. t_{RC=}.Read Cycle Time.



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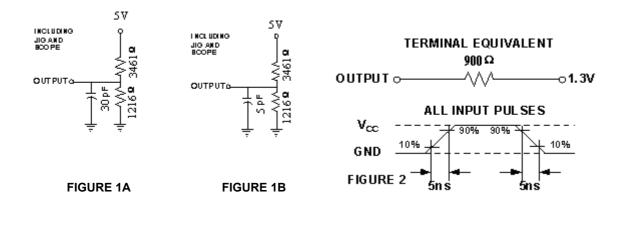
CS18LV02565

■ LOW Vcc DATA RETENTION WAVEFORM (/CE Controlled)



■ AC TEST COND	ITIONS	■ KEY TO S	SWITCHING	WAVEFORMS
Input Pulse Levels	Vcc/0V	WAVEFORMS	INPUTS	OUTPUTS
Input Rise and Fall Times	5ns		MUST BE STEADY	MUST BE STEADY
Input and Output Timing Reference Level	0.5Vcc		MAY CHANGE FROM H TO L	WILL BE CHANGE FROM H TO L
			MAY CHANGE FROM L TO H	WILL BE CHANGE FROM L TO H
	0	XXXXX	DON'T CARE ANY CHANGE PERMITTED	CHANGE STATE UNKNOWN
			DOES NOT APPLY	CENTER LINE IS HIGH IMPEDANCE OFF STATE

■ AC TEST LOADS AND WAVEFORMS



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CS18LV02565

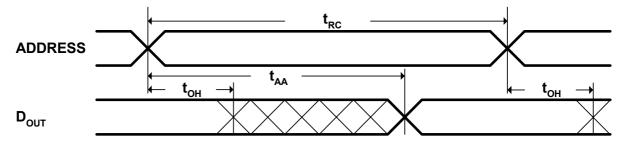
Rev. 2.0

■ AC ELECTRICAL CHARACTERISTICS (TA = 0° ~70°C, Vcc = 5.0V) < READ CYCLE >

JEDEC	Symbol	Description	-5	-55		-70	
Name	Symbol			MAX	MIN	MAX	Unit
t _{AVAX}	t _{RC}	Read Cycle Time	55		70		ns
t _{AVQV}	t _{AA}	Address Access Time		55		70	ns
t _{ELQV}	t _{ACE}	Chip Select Access Time		55		70	ns
t _{GLQV}	t _{OE}	Output Enable to Output		30		50	ns
		Valid					
t _{ELQX}	t _{c∟z}	Chip Select to Output Low Z	10		10		ns
t _{GLQX}	t _{oLZ}	Output Enable to Output in	5		5	1	ns
		Low Z		- 4	36 . ¹⁰		
t _{EHQZ}	t _{CHZ}	Chip Deselect to Output in	0 9	35	0	35	ns
		High Z	32	05			
t _{GHQZ}	t _{онz}	Output Disable to Output in	0	30	0	30	ns
		High Z					
t _{AXOX}	t _{он}	Address Change to Out	10		10		ns
		Disable					

SWITCHING WAVEFORMS (READ CYCLE)

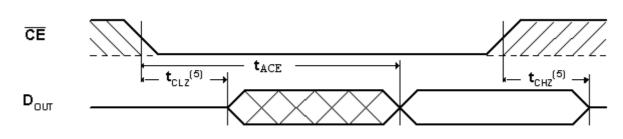
READ CYCLE1 (1,2,4)



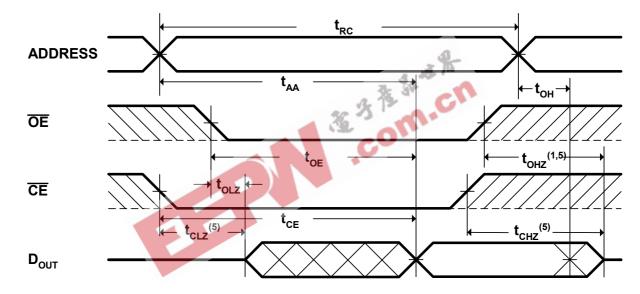


CS18LV02565

READ CYCLE2 (1,3,4)



READ CYCLE3 (1,4)



NOTES:

- 1. /WE is high in read Cycle.
- 2. Device is continuously selected when /CE = V_{IL} .
- 3. Address valid prior to or coincident with CE transition low.
- 4. /OE = VIL.
- 5. Test conditions assume signal transition times of 5ns or less, timing reference levels of 0.5VCC, input pulse levels of 0V to VCC and output loading specified in Figure 1A.
- 6. Transition is measured \pm 500mV from steady state with C_L = 5pF as shown in Figure 1B. The parameter is guaranteed but not 100% tested.



32K-Word By 8 Bit

CS18LV02565

■ AC ELECTRICAL CHARACTERISTICS (TA = 0° ~70°C, Vcc = 5.0V) < WRITE CYCLE >

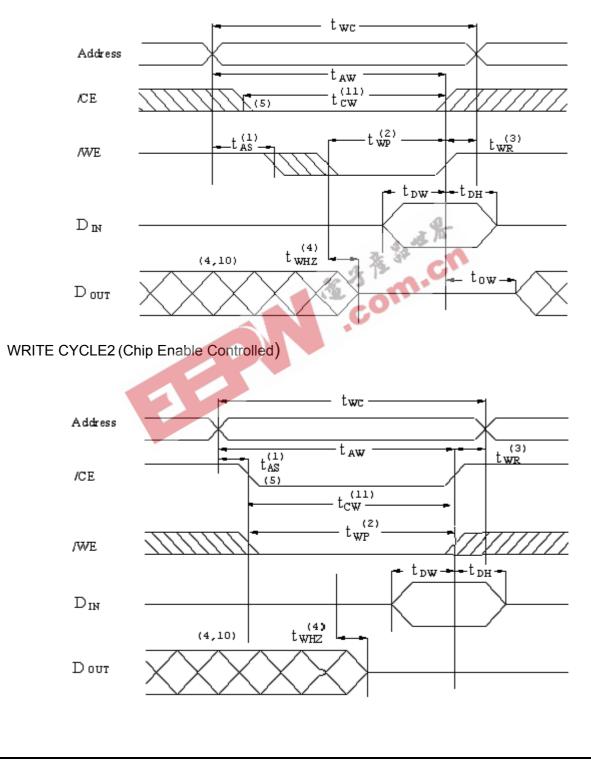
JEDEC	Symbol	Description	-5	55	-7	' 0	Unit
Name	Symbol	Description	MIN	MAX	MIN	MAX	Unit
t _{AVAX}	t _{wc}	Write Cycle Time	55		70		ns
t _{E1LWH}	t _{cw}	Chip Select to End of Write	55		70		ns
t _{AVWL}	t _{AS}	Address Setup Time	0		0		ns
t _{avwh}	t _{AW}	Address Valid to End of Write	55		70		ns
t _{w∟wн}	t _{wP}	Write Pulse Width	40		50		ns
t _{whax}	t _{wR}	Write Recovery Time	0		0		ns
t _{wLQZ}	t _{wHz}	Write to Output in High Z		25	- 8-	35	ns
t _{DVWH}	t _{DW}	Data to Write Time Overlap	20	. 44	30		ns
t _{wHDX}	t _{DH}	Data Hold for Write End	0	3	0		ns
t _{GHQZ}	t _{онz}	Output Disable to Output in High Z	0	30	0	30	ns
t _{whox}	t _{ow}	End of Write to Output Active	5		5		ns
		3					



CS18LV02565

SWITCHING WAVEFORMS (WRITE CYCLE)

WRITE CYCLE1 (Write Enable Controlled)



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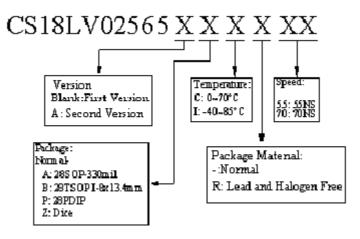


CS18LV02565

NOTES:

- 1. /WE must be high during address transitions.
- 2. The internal write time of the memory is defined by the overlap of /CE and /WE low. All signals must be active to initiate a write and any one signal can terminate a write by going inactive. The data input setup and hold timing should be referenced to the second transition edge of the signal that terminates the write.
- 3. T_{WR} is measured from the earlier of /CE or /WE going high at the end of write cycle.
- 4. During this period, DQ pins are in the output state so that the input signals of opposite phase to the outputs must not be applied.
- 5. If the /CE low transition occurs simultaneously with the /WE low transitions or after the /WE transition, output remain in a high impedance state.
- 6. /OE is continuously low (/OE = V_{IL}). D_{OUT} is the same phase of write data of this write cycle.
- 7. D_{OUT} is the read data of next address.
- 8. If /CE is low during this period, DQ pins are in the output state. Then the data input signals of opposite phase to the outputs must not be applied to them.
- 9. Test conditions assume signal transition times of 5ns or less, timing reference levels of 0.5VCC, input pulse levels of 0V to VCC and output loading specified in Figure 1A.
- 10. Transition is measured \pm 500mV from steady state with C_L = 5pF as shown in Figure 1B. The parameter is guaranteed but not 100% tested.
- 11. T_{cw} is measured from the later of /CE going low to the end of write.

ORDER INFORMATION



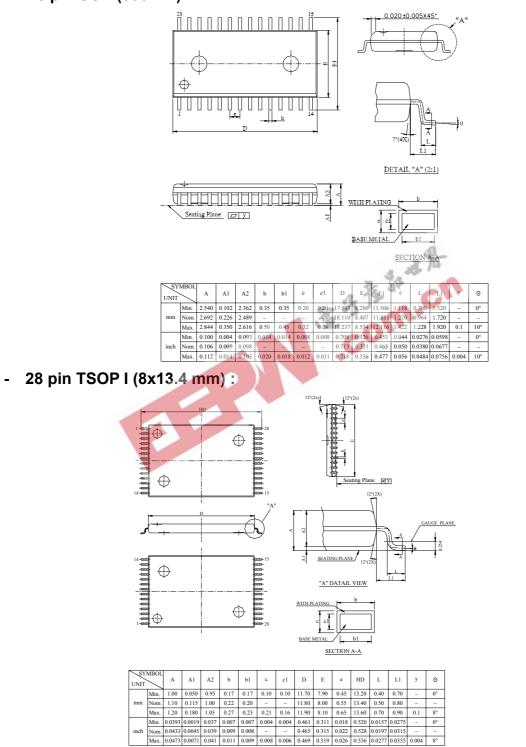
12



CS18LV02565

■ PACKAGE DIMENSIONS

- 28 pin SOP (330 mil) :



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13



CS18LV02565

- 28 pin PDIP (600mil):

